

# Supporting Information

## Spontaneous Registration of Sub-10 Nanometer Features Based on Sub-Zero-Celsius Spin-Casting of Self-Assembling Building Blocks Directed by Chemically-Encoded Surfaces

Jung Hye Lee,<sup>1,†</sup> Hak-Jong Choi,<sup>2,†,‡</sup> ChulHee Lee,<sup>1</sup> Seung Won Song,<sup>1</sup> Joong Bum Lee,<sup>1</sup>

Daihong Huh,<sup>2</sup> Yoon Sung Nam,<sup>1</sup> Duk Young Jeon,<sup>1</sup> Heon Lee,<sup>2,\*</sup> and Yeon Sik Jung<sup>1,\*</sup>

<sup>1</sup>Dept. of Materials Science and Engineering, Korea Advanced Institute of Science and Technology (KAIST), 291 Daehak-ro, Yuseong-gu, Daejeon 34141, Republic of Korea

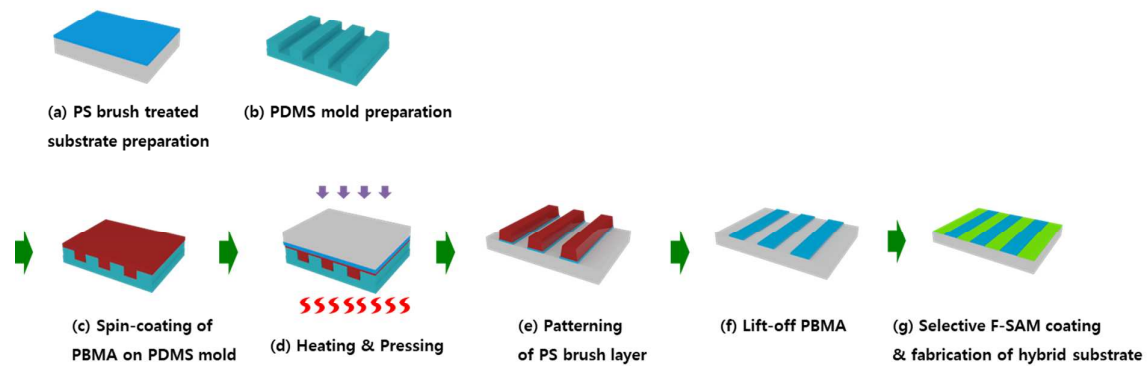
<sup>2</sup>Department of Materials Science and Engineering, Korea University, 145 Anam-ro, Seongbuk-gu, Seoul, 02841, Republic of Korea

Present Address of Dr. H.-J. Choi

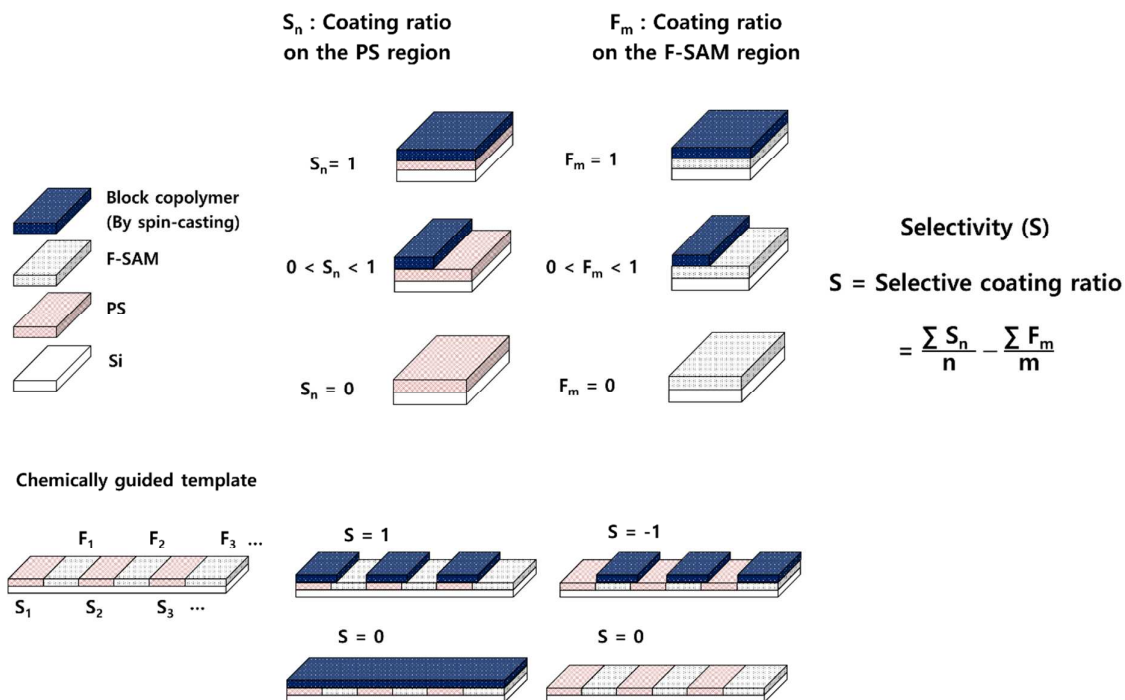
<sup>‡</sup>University of Pennsylvania, Dept. of Electrical and Systems Engineering, 200 South 33rd street, Philadelphia, PA, USA, 19104

**Table S1. Vapor pressure data of solvents depending on temperature**

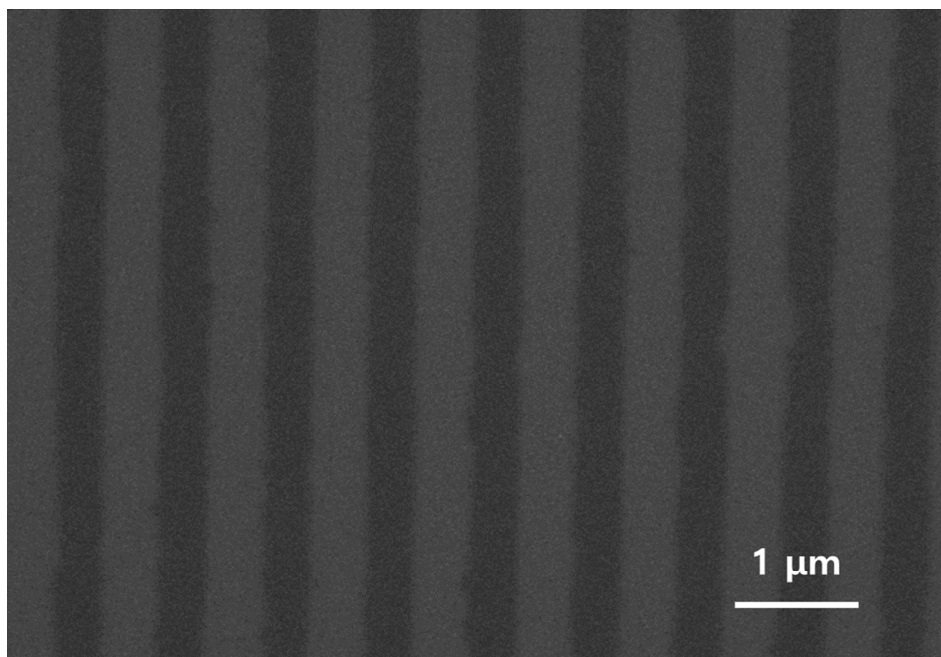
	Vapor pressure (mmHg)						
	@ -15℃	@ -5℃	@ 5℃	@ 15℃	@ 25℃	@ 35℃	@ 45℃
<b>Heptane</b>	4.0822	8.0520	14.958	26.372	44.406	71.799	111.98
<b>Toluene</b>	2.4747	4.9160	9.2137	16.408	27.935	45.693	72.122
<b>PGMEA</b>	0.19191	0.48902	1.1335	2.4230	4.8303	9.0628	16.126



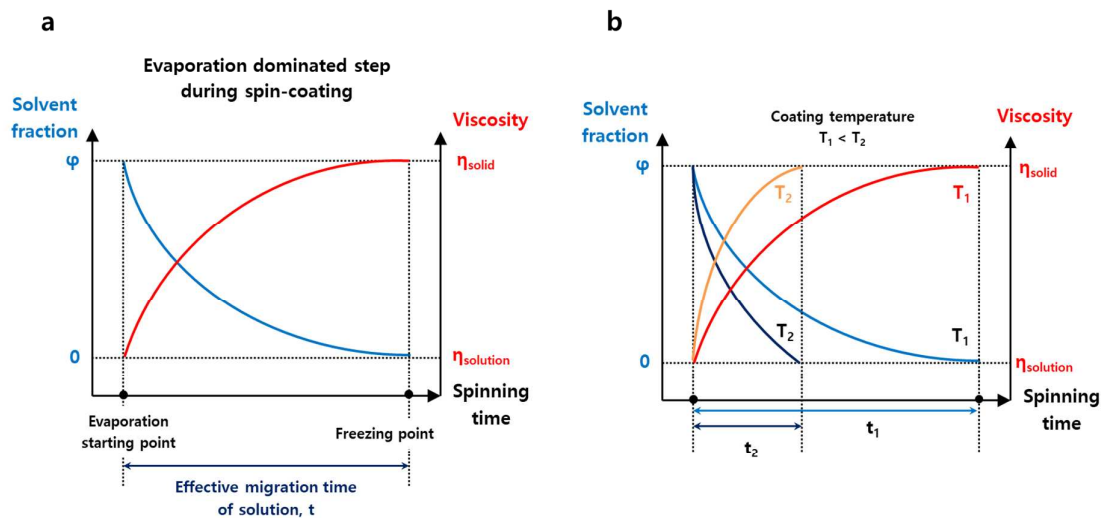
**Figure S1.** Process flow of SAM patterning *via* transfer printing and reactive ion etching.



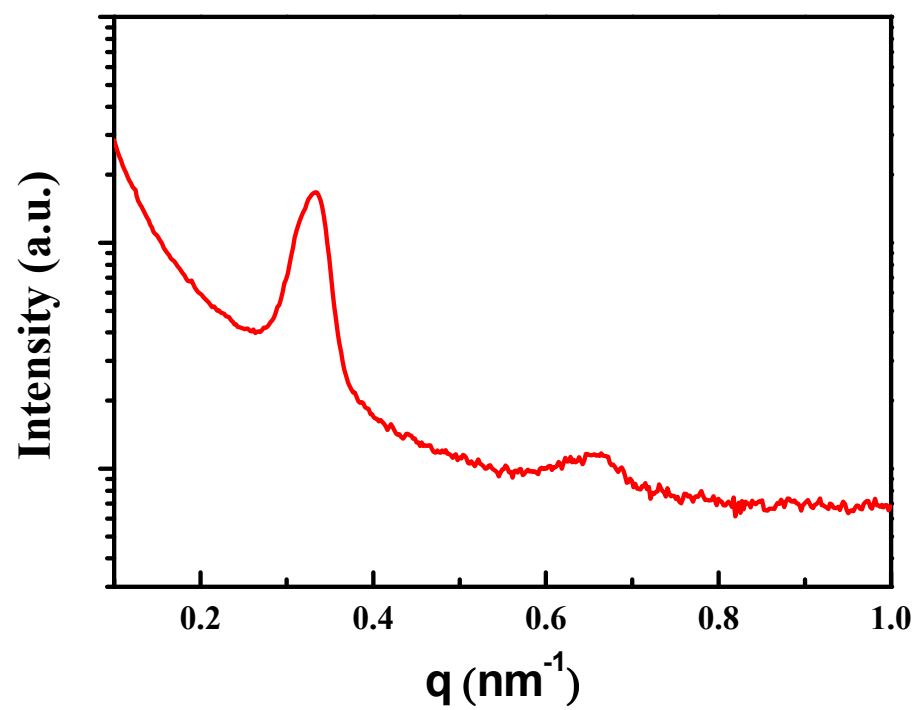
**Figure S2.** Definition of selectivity of spun-cast thin film on the patterned SAM substrate.



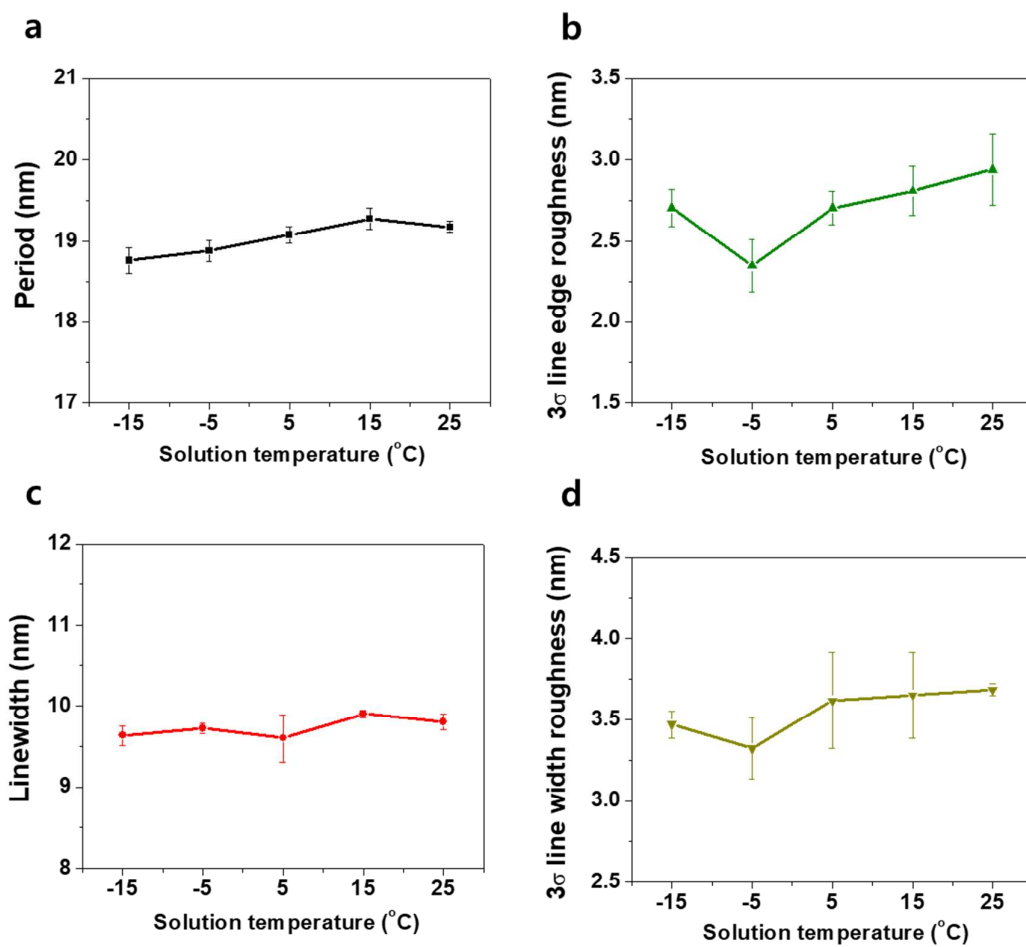
**Figure S3.** BCP thin films patterned with S-CSC at -5°C.



**Figure S4.** Illustration of effective migration time of solution depending on spin-casting temperature. (a) Effective migration time is defined as the time before the saturation of viscosity with evaporation of solvent during spin coating. (b) Lower spin-casting temperature allows a longer migration time.

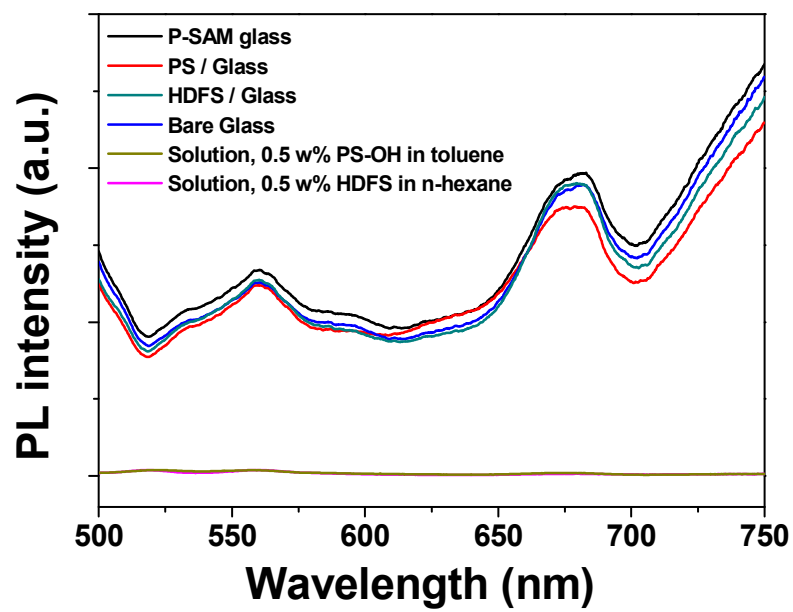


**Figure S5.** GISAXS data of the patterned BCP obtained with S-CSC at -5°C.

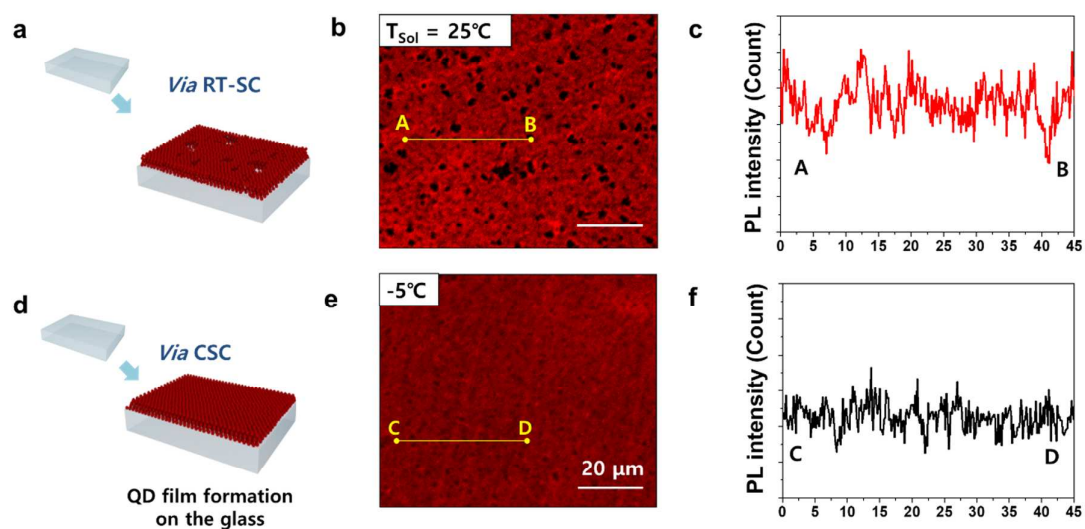


**Figure S6.** Pattern quality analysis of BCP patterns obtained from S-CSC, thermal annealing, and reactive ion etching.

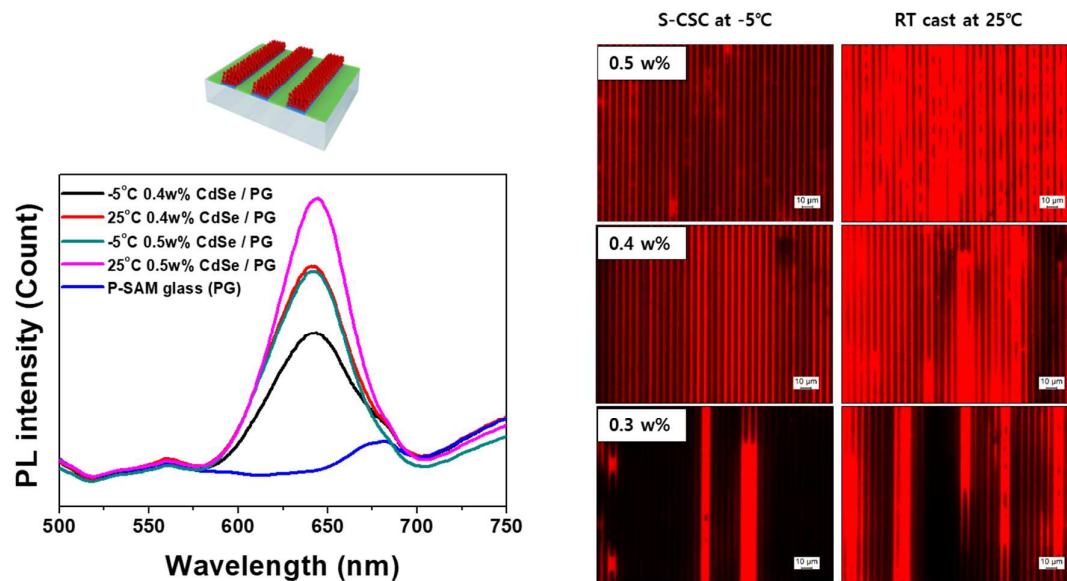




**Figure S7.** PL intensity profiles of the SAM patterns on glass substrate.



**Figure S8.** Fluorescence characteristics of CdSe QD on non-patterned glass substrate. (a), (b), and (c) RT cast at 25°C and (d), (e), and (f) CSC at -5°C. (a) & (d) illustrations, (b) & (e) confocal microscopy images, and (c) & (f) emission intensity profiles.



**Figure S9.** Fluorescence microscopy images and PL intensity of CdSe QD patterns depending on spin-casting temperature and QD concentration (from 0.5 to 0.3 w% in toluene).